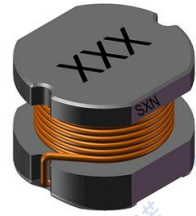


Unshielded SMD Power Inductors



SM Series, Unshielded SMD Power Inductors



◆特征:

- 镀银型低成本设计
- 非屏蔽功率电感
- 适用于表面贴装设备
- 小尺寸耐大电流，低直流电阻
- 符合 RoHS,无卤和 REACH

Features:

- Silver plated type, Low cost design
- Unshielded power inductor
- Suitable for surface mounting equipment
- Small size, high rated current, low DCR
- RoHS, Halogen Free and REACH Compliance

◆用途:

- 录影机
- 液晶电视
- 笔记本电脑
- 小型通信机器.
- DC/DC 转换器等

Applications:

- Power supply for VTRs
- LCD televisions
- Notebook PCs
- Portable communication equipment Automotive
- DC/DC converters, etc

◆环境:

- 工作温度: -40℃ 至+125℃
(包括线圈自身温升)

Environmental Data:

- Operating Temperature: -40℃ to +125℃
(Including coils self-temperature rise)

◆试验设备:

- 电感值:HP4284A, HP4285A 或同等仪器
- 电流:HP4284+42841A
- 自谐振频率:Agilent E4991A
- 直流电阻: Chroma 16502 或同等仪器

Test Equipment:

- L:HP4284A or HP4285A LCR meter or equivalent
- Isat & Irms: HP4284+42841A
- SRF:Agilent E4991A
- DCR:Chroma 16502 or equivalent

◆产品型号:

Product Identification:

SM

①

1054

②

100

③

K

④

I

⑤

①	
类型 Type	
SM	非屏蔽磁路贴片电感 Unshielded SMT Power Inductors I

②	
外形尺寸(L×W×H) (mm) External Dimensions (L×W×H) (mm)	
1054	10×5.4

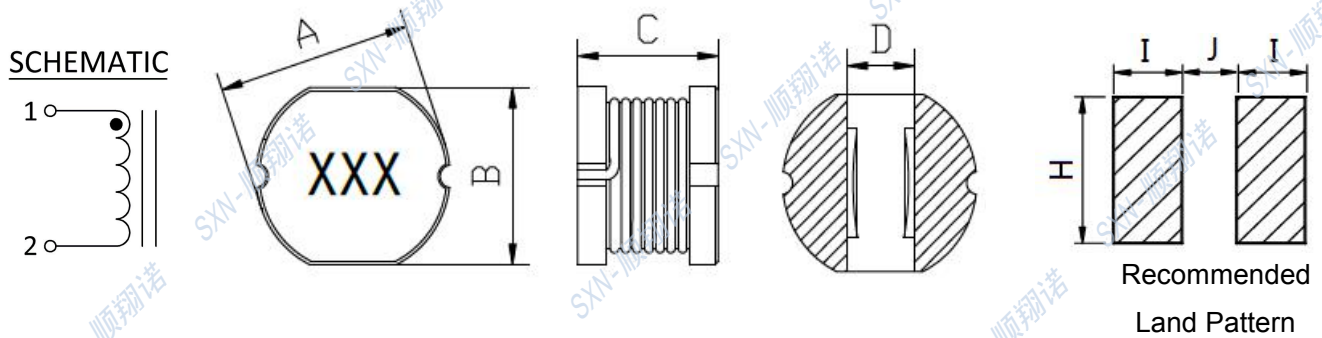
③
Inductance
10 uH

④
公差 Inductance Tolerance
J:±5%,K: ±10%, L: ±15% M: ±20%,P: ±25%, N: ±30%

⑤	
包装 Packing	
B	散装Bulk Package
T	编带Tape & Reel

◆外观尺寸:

Shape and Dimensions(dimensions are in mm):



Part No	ITEM						
	A	B	C	D	H	I	J
SM3511	3.5±0.3	3.0±0.3	1.1±0.2	1.0	3.5	1.6	0.8
SM3516	3.5±0.3	3.0±0.3	1.6±0.2	1.0	3.5	1.6	0.8
SM3521	3.5±0.3	3.0±0.3	2.1±0.3	1.0	3.5	1.6	0.8
SM4532	4.5±0.3	4.0±0.3	3.2±0.3	1.2	4.5	1.75	1.5
SM5825	5.8±0.3	5.2±0.3	2.5±0.3	2.0	5.5	2.15	1.7
SM5835	5.8±0.3	5.2±0.3	3.5±0.3	2.0	5.5	2.15	1.7
SM5845	5.8±0.3	5.2±0.3	4.5±0.35	2.0	5.5	2.15	1.7
SM7835	7.8±0.3	7.0±0.3	3.5±0.5	2.1	7.5	3.0	2.0
SM7850	7.8±0.3	7.0±0.3	5.0±0.5	2.1	7.5	3.0	2.0
SM1040	10.0±0.3	9.0±0.3	4.0±0.5	2.1	9.5	3.75	2.5
SM1054	10.0±0.3	9.0±0.3	5.4±0.5	2.1	9.5	3.75	2.5

◆规格特性:

Specifications:

● SM3511 Series Electrical Characteristics (Electrical specifications at 25°C)

Part No	Inductance			SRF	DCR	Saturation Current	Temperature Rise Current
	L(μH) '@0A	Tole	Test Freq	MHz Typ	(Ω) Max	(A) Max	(A) Max
SM3511-2R2M	2.2	M	1MHz	62	0.24	1.60	1.00
SM3511-3R3M	3.3	M	1MHz	47	0.27	1.40	0.90
SM3511-4R7M	4.7	M	1MHz	38	0.30	1.10	0.80
SM3511-6R8M	6.8	M	1MHz	31	0.47	0.90	0.76
SM3511-8R2M	8.2	M	1MHz	27	0.52	0.80	0.72
SM3511-100M	10.0	M	1MHz	23	0.55	0.75	0.66
SM3511-120M	12.0	M	1MHz	21	0.75	0.60	0.54
SM3511-150M	15.0	M	1MHz	19	0.91	0.50	0.45
SM3511-220M	22.0	M	1MHz	15	1.20	0.40	0.36
SM3511-270M	27.0	M	1MHz	14	1.50	0.35	0.30

● SM3516 Series Electrical Characteristics (Electrical specifications at 25°C)

Part No	Inductance			SRF	DCR	Saturation Current	Temperature Rise Current
	L(μH) '@0A	Tole	Test Freq	MHz Typ	(Ω) Max	(A) Max	(A) Max
SM3516-2R2M	2.2	M	1MHz	62	0.24	2.00	1.20
SM3516-3R3M	3.3	M	1MHz	47	0.27	1.50	1.08
SM3516-4R7M	4.7	M	1MHz	38	0.30	1.20	1.00
SM3516-6R8M	6.8	M	1MHz	31	0.47	1.00	0.80
SM3516-8R2M	8.2	M	1MHz	27	0.52	0.85	0.76
SM3516-100M	10.0	M	1MHz	23	0.55	0.75	0.70
SM3516-120M	12.0	M	1MHz	21	0.75	0.70	0.60
SM3516-150M	15.0	M	1MHz	19	0.91	0.60	0.50
SM3516-220M	22.0	M	1MHz	15	1.20	0.50	0.40
SM3516-270M	27.0	M	1MHz	14	1.50	0.40	0.36

• SM3521 Series Electrical Characteristics (Electrical specifications at 25°C)

Part No	Inductance			SRF	DCR	Saturation Current	Temperature Rise Current
	L(μH) '@0A	Tole	Test Freq	MHz Typ	(Ω) Max	(A) Max	(A) Max
SM3521-1R0M	1.0	M	7.96MHz	120	0.045	3.30	2.20
SM3521-1R2M	1.2	M	7.96MHz	100	0.050	3.00	2.10
SM3521-1R5M	1.5	M	7.96MHz	85	0.055	2.70	1.70
SM3521-1R8M	1.8	M	7.96MHz	75	0.070	2.50	1.65
SM3521-2R2M	2.2	M	7.96MHz	62	0.085	2.30	1.60
SM3521-2R7M	2.7	M	7.96MHz	53	0.100	2.20	1.40
SM3521-3R3M	3.3	M	7.96MHz	47	0.120	1.95	1.04
SM3521-3R9M	3.9	M	7.96MHz	41	0.125	1.85	1.00
SM3521-4R7M	4.7	M	7.96MHz	38	0.135	1.60	1.00
SM3521-5R6M	5.6	M	7.96MHz	33	0.145	1.55	0.95
SM3521-6R8M	6.8	M	7.96MHz	31	0.20	1.40	0.95
SM3521-8R2M	8.2	M	7.96MHz	27	0.25	1.20	0.92
SM3521-100M	10	M	2.52MHz	23	0.32	1.05	0.90
SM3521-120M	12	M	2.52MHz	21	0.35	1.00	0.85
SM3521-150M	15	M	2.52MHz	19	0.46	0.90	0.75
SM3521-180M	18	M	2.52MHz	17	0.52	0.80	0.70
SM3521-220M	22	M	2.52MHz	15	0.65	0.75	0.60
SM3521-270M	27	M	2.52MHz	14	0.75	0.70	0.55
SM3521-330M	33	M	2.52MHz	12	0.92	0.60	0.50
SM3521-390M	39	M	2.52MHz	11	1.12	0.55	0.48
SM3521-470M	47	M	2.52MHz	10	1.27	0.50	0.45
SM3521-560M	56	M	2.52MHz	9.3	1.50	0.45	0.30
SM3521-680M	68	M	2.52MHz	8.4	2.00	0.40	0.26
SM3521-820M	82	M	2.52MHz	7.5	2.15	0.35	0.23
SM3521-101M	100	M	1KHz	6.8	2.80	0.34	0.20
SM3521-121K	120	K	1KHz	6.2	3.40	0.33	0.18
SM3521-151K	150	K	1KHz	5.5	4.20	0.28	0.16
SM3521-181K	180	K	1KHz	5.0	4.50	0.27	0.15
SM3521-221K	220	K	1KHz	4.5	5.70	0.25	0.14
SM3521-271K	270	K	1KHz	4.0	8.50	0.22	0.10
SM3521-331K	330	K	1KHz	3.6	9.50	0.19	0.09

• SM4532 Series Electrical Characteristics (Electrical specifications at 25°C)

Part No	Inductance			SRF	DCR	Saturation Current	Temperature Rise Current
	L(μH) '@0A	Tole	Test Freq	MHz Typ	(Ω) Max	(A) Max	(A) Max
SM4532-1R0M	1.0	M	7.96MHz	120	0.026	3.85	2.56
SM4532-1R4M	1.4	M	7.96MHz	95	0.035	3.40	2.52
SM4532-1R8M	1.8	M	7.96MHz	75	0.038	2.90	1.95
SM4532-2R2M	2.2	M	7.96MHz	62	0.042	2.80	1.75
SM4532-2R7M	2.7	M	7.96MHz	53	0.048	2.75	1.58
SM4532-3R3M	3.3	M	7.96MHz	47	0.060	2.48	1.44
SM4532-3R9M	3.9	M	7.96MHz	41	0.070	2.30	1.33
SM4532-4R7M	4.7	M	7.96MHz	38	0.080	2.00	1.15
SM4532-5R6M	5.6	M	7.96MHz	33	0.080	1.95	0.99
SM4532-6R8M	6.8	M	7.96MHz	31	0.100	1.60	0.95
SM4532-8R2M	8.2	M	7.96MHz	27	0.120	1.50	0.84
SM4532-100M	10	M	2.52MHz	23	0.150	1.45	1.04
SM4532-120M	12	M	2.52MHz	21	0.16	1.20	0.97
SM4532-150M	15	M	2.52MHz	19	0.20	1.12	0.85
SM4532-180M	18	M	2.52MHz	17	0.23	1.00	0.74
SM4532-220M	22	M	2.52MHz	15	0.27	0.96	0.68
SM4532-270M	27	M	2.52MHz	14	0.331	0.84	0.62
SM4532-330M	33	M	2.52MHz	12	0.35	0.75	0.56
SM4532-390M	39	M	2.52MHz	11	0.40	0.70	0.52
SM4532-470K	47	K	2.52MHz	10	0.53	0.68	0.44
SM4532-560K	56	K	2.52MHz	9.3	0.60	0.60	0.42
SM4532-680K	68	K	2.52MHz	8.4	0.74	0.50	0.37
SM4532-820K	82	K	2.52MHz	8.0	0.88	0.46	0.29
SM4532-101K	100	K	1KHz	7.2	1.20	0.45	0.26
SM4532-121K	120	K	1KHz	6.5	1.25	0.44	0.24
SM4532-151K	150	K	1KHz	5.8	1.60	0.37	0.22
SM4532-181K	180	K	1KHz	5.0	2.00	0.30	0.19
SM4532-221K	220	K	1KHz	4.3	3.08	0.29	0.18
SM4532-331K	220	K	1KHz	3.5	3.55	0.24	0.15
SM4532-391K	220	K	1KHz	3.0	4.20	0.21	0.13
SM4532-471K	220	K	1KHz	2.6	4.90	0.18	0.12
SM4532-561K	220	K	1KHz	2.0	6.50	0.15	0.10

• SM5825 Series Electrical Characteristics (Electrical specifications at 25°C)

Part No	Inductance			SRF	DCR	Saturation Current	Temperature Rise Current
	L(μH) '@0A	Tole	Test Freq	MHz Typ	(Ω) Max	(A) Max	(A) Max
SM5825-1R2M	1.2	M	7.96MHz	100	0.050	5.20	4.20
SM5825-1R5M	1.5	M	7.96MHz	85	0.060	4.60	4.00
SM5825-1R8M	1.8	M	7.96MHz	75	0.065	4.00	3.70
SM5825-2R2M	2.2	M	7.96MHz	62	0.07	3.60	3.50
SM5825-2R7M	2.7	M	7.96MHz	53	0.08	3.50	3.20
SM5825-3R3M	3.3	M	7.96MHz	47	0.10	2.85	2.70
SM5825-3R9M	3.9	M	7.96MHz	41	0.12	2.80	2.40
SM5825-4R7M	4.7	M	7.96MHz	38	0.14	2.65	2.00
SM5825-5R6M	5.6	M	7.96MHz	33	0.15	2.40	1.80
SM5825-6R8M	6.8	M	7.96MHz	31	0.16	2.10	1.50
SM5825-8R2M	8.2	M	7.96MHz	27	0.18	2.00	1.40
SM5825-100M	10	M	2.52MHz	23	0.20	1.85	1.30
SM5825-120M	12	M	2.52MHz	21	0.23	1.60	1.10
SM5825-150M	15	M	2.52MHz	19	0.25	1.45	1.05
SM5825-180M	18	M	2.52MHz	17	0.30	1.35	1.00
SM5825-220M	22	M	2.52MHz	15	0.35	1.20	0.90
SM5825-270M	27	M	2.52MHz	14	0.40	1.10	0.85
SM5825-330M	33	M	2.52MHz	12	0.50	0.95	0.75
SM5825-390M	39	M	2.52MHz	11	0.55	0.90	0.70
SM5825-470K	47	K	2.52MHz	10	0.65	0.85	0.60
SM5825-560K	56	K	2.52MHz	9.3	0.75	0.80	0.55
SM5825-680K	68	K	2.52MHz	8.4	0.95	0.70	0.50
SM5825-820K	82	K	2.52MHz	7.5	1.20	0.65	0.45
SM5825-101K	100	K	1KHz	6.8	1.40	0.55	0.40
SM5825-121K	120	K	1KHz	6.2	1.75	0.50	0.35
SM5825-151K	150	K	1KHz	5.5	2.00	0.48	0.25
SM5825-181K	180	K	1KHz	5.0	2.60	0.45	0.22
SM5825-221K	220	K	1KHz	4.5	3.00	0.40	0.20
SM5825-271K	270	K	1KHz	4.0	3.70	0.35	0.18
SM5825-331K	330	K	1KHz	3.6	4.30	0.32	0.17
SM5825-391K	390	K	1KHz	3.0	6.00	0.30	0.16
SM5825-471K	470	K	1KHz	2.7	6.70	0.28	0.15

• SM5830 Series Electrical Characteristics (Electrical specifications at 25°C)

Part No	Inductance			SRF	DCR	Saturation Current	Temperature Rise Current
	L(μH) '@0A	Tole	Test Freq	MHz Typ	(Ω) Max	(A) Max	(A) Max
SM5835-1R0M	1.0	M	7.96MHz	120	0.03	6.70	4.50
SM5835-1R2M	1.2	M	7.96MHz	100	0.03	6.00	4.20
SM5835-1R5M	1.5	M	7.96MHz	85	0.03	5.60	4.10
SM5835-1R8M	1.8	M	7.96MHz	75	0.03	5.60	3.70
SM5835-2R2M	2.2	M	7.96MHz	62	0.03	4.40	3.50
SM5835-2R7M	2.7	M	7.96MHz	53	0.04	4.20	3.20
SM5835-3R3M	3.3	M	7.96MHz	47	0.05	4.00	2.80
SM5835-3R9M	3.9	M	7.96MHz	41	0.06	3.60	2.60
SM5835-4R7M	4.7	M	7.96MHz	38	0.07	3.10	2.50
SM5835-5R6M	5.6	M	7.96MHz	33	0.08	2.80	2.40
SM5835-6R8M	6.8	M	7.96MHz	31	0.09	2.75	2.20
SM5835-8R2M	8.2	M	7.96MHz	27	0.10	2.65	2.00
SM5835-100M	10	M	2.52MHz	23	0.13	2.15	1.80
SM5835-120M	12	M	2.52MHz	21	0.16	2.00	1.75
SM5835-150M	15	M	2.52MHz	19	0.19	1.85	1.70
SM5835-180M	18	M	2.52MHz	17	0.21	1.68	1.60
SM5835-220M	22	M	2.52MHz	15	0.28	1.45	1.50
SM5835-270M	27	M	2.52MHz	14	0.32	1.35	1.40
SM5835-330M	33	M	2.52MHz	12	0.38	1.20	1.10
SM5835-390M	39	M	2.52MHz	11	0.42	1.10	1.00
SM5835-470K	47	K	2.52MHz	10	0.52	1.05	0.90
SM5835-560K	56	M	2.52MHz	9.3	0.56	0.95	0.85
SM5835-680K	68	K	2.52MHz	8.4	0.68	0.88	0.80
SM5835-820K	82	K	2.52MHz	7.5	0.82	0.80	0.65
SM5835-101K	100	K	1KHz	6.8	1.10	0.75	0.60
SM5835-121K	120	K	1KHz	6.2	1.20	0.65	0.58
SM5835-151K	150	K	1KHz	5.5	1.50	0.60	0.43
SM5835-181K	180	K	1KHz	5.0	1.80	0.56	0.41
SM5835-221K	220	K	1KHz	4.5	2.00	0.48	0.37
SM5835-271K	270	K	1KHz	4.0	2.90	0.44	0.35
SM5835-331K	330	K	1KHz	3.6	3.30	0.40	0.28
SM5835-391K	390	K	1KHz	3.0	3.70	0.38	0.26
SM5835-471K	470	K	1KHz	2.7	4.90	0.36	0.20

• SM5845 Series Electrical Characteristics (Electrical specifications at 25°C)

Part No	Inductance			SRF	DCR	Saturation Current	Temperature Rise Current
	L(μH) '@0A	Tole	Test Freq	MHz Typ	(Ω) Max	(A) Max	(A) Max
SM5845-1R0M	1.0	M	7.96MHz	120	0.013	6.00	5.40
SM5845-1R5M	1.5	M	7.96MHz	85	0.017	5.00	4.70
SM5845-3R3M	3.3	M	7.96MHz	47	0.031	4.00	3.70
SM5845-4R7M	4.7	M	7.96MHz	38	0.052	3.50	3.10
SM5845-6R8M	6.8	M	7.96MHz	31	0.059	3.00	2.40
SM5845-8R2M	8.2	M	7.96MHz	27	0.062	2.50	2.00
SM5845-100M	10	M	2.52MHz	23	0.10	1.60	1.44
SM5845-120M	12	M	2.52MHz	21	0.12	1.45	1.40
SM5845-150M	15	M	2.52MHz	19	0.14	1.25	1.30
SM5845-180M	18	M	2.52MHz	17	0.15	1.16	1.23
SM5845-220M	22	M	2.52MHz	15	0.18	1.12	1.11
SM5845-270M	27	M	2.52MHz	14	0.20	1.04	0.97
SM5845-330M	33	M	2.52MHz	12	0.23	0.96	0.88
SM5845-390M	39	M	2.52MHz	11	0.32	0.85	0.80
SM5845-470K	47	K	2.52MHz	10	0.37	0.80	0.72
SM5845-560K	56	K	2.52MHz	9.3	0.42	0.72	0.68
SM5845-680K	68	K	2.52MHz	8.4	0.46	0.68	0.61
SM5845-820K	82	K	2.52MHz	7.5	0.60	0.64	0.58
SM5845-101K	100	K	1KHz	6.8	0.70	0.56	0.52
SM5845-121K	120	K	1KHz	6.2	0.93	0.52	0.48
SM5845-151K	150	K	1KHz	5.5	1.10	0.44	0.40
SM5845-181K	180	K	1KHz	5.0	1.83	0.40	0.38
SM5845-221K	220	K	1KHz	4.5	1.57	0.36	0.35
SM5845-331K	330	K	1KHz	4.0	1.76	0.34	0.28
SM5845-471K	470	K	1KHz	3.5	2.99	0.32	0.24
SM5845-681K	680	K	1KHz	3.0	3.90	0.29	0.20
SM5845-102K	1000	K	1KHz	2.5	5.80	0.26	0.19

• SM7835 Series Electrical Characteristics (Electrical specifications at 25°C)

Part No	Inductance			SRF	DCR	Saturation Current	Temperature Rise Current
	L(μH) '@0A	Tole	Test Freq	MHz Typ	(Ω) Max	(A) Max	(A) Max
SM7835-100M	10	M	2.52MHz	120	0.0803	2.40	1.44
SM7835-120M	12	M	2.52MHz	100	.0897	2.10	1.39
SM7835-150M	15	M	2.52MHz	95	0.104	1.90	1.24
SM7835-180M	18	M	2.52MHz	85	0.111	1.80	1.12
SM7835-220M	22	M	2.52MHz	75	0.129	1.60	1.07
SM7835-270M	27	M	2.52MHz	62	0.153	1.50	0.94
SM7835-330M	33	M	2.52MHz	53	0.170	1.28	0.85
SM7835-390M	39	M	2.52MHz	47	0.217	1.24	0.74
SM7835-470K	47	K	2.52MHz	41	0.252	1.10	0.68
SM7835-560K	56	K	2.52MHz	38	0.282	1.05	0.64
SM7835-680K	68	K	2.52MHz	33	0.332	0.90	0.59
SM7835-820K	82	K	2.52MHz	31	0.406	0.85	0.54
SM7835-101K	100	K	1KHz	27	0.481	0.78	0.51
SM7835-121K	120	K	1KHz	23	0.536	0.70	0.49
SM7835-151K	150	K	1KHz	21	0.755	0.60	0.40
SM7835-181K	180	K	1KHz	19	1.022	0.56	0.36
SM7835-221K	220	K	1KHz	17	1.200	0.52	0.31
SM7835-271K	270	K	1KHz	15	1.306	0.48	0.29
SM7835-331K	330	K	1KHz	14	1.495	0.44	0.28

• SM7850 Series Electrical Characteristics (Electrical specifications at 25°C)

Part No	Inductance			SRF	DCR	Saturation Current	Temperature Rise Current
	L(μH) '@0A	Tole	Test Freq	MHz Typ	(Ω) Max	(A) Max	(A) Max
SM7850-1R0M	1.0	M	7.96MHz	145	0.013	7.00	5.20
SM7850-2R2M	2.2	M	7.96MHz	140	0.015	6.00	4.80
SM7850-4R7M	4.7	M	7.96MHz	135	0.026	5.00	3.80
SM7850-6R8M	6.8	M	7.96MHz	130	0.033	4.00	2.80
SM7850-8R2M	8.2	M	7.96MHz	125	0.039	3.50	2.55
SM7850-100M	10	M	2.52MHz	120	0.042	2.85	2.30
SM7850-120M	12	M	2.52MHz	100	0.049	2.50	2.00
SM7850-150M	15	M	2.52MHz	95	0.072	2.20	1.80
SM7850-180M	18	M	2.52MHz	85	0.085	2.00	1.60
SM7850-220M	22	M	2.52MHz	75	0.091	1.95	1.50
SM7850-270M	27	M	2.52MHz	62	0.107	1.75	1.30
SM7850-330M	33	M	2.52MHz	53	0.115	1.50	1.20
SM7850-390M	39	M	2.52MHz	47	0.120	1.40	1.10
SM7850-470K	47	K	2.52MHz	41	0.150	1.28	1.10
SM7850-560K	56	K	2.52MHz	38	0.176	1.20	0.94
SM7850-680K	68	K	2.52MHz	33	0.208	1.12	0.85
SM7850-820K	82	K	2.52MHz	31	0.238	1.04	0.78
SM7850-101K	100	K	1KHz	27	0.273	0.92	0.72
SM7850-121K	120	K	1KHz	23	0.325	0.80	0.66
SM7850-151K	150	K	1KHz	21	0.390	0.72	0.58
SM7850-181K	180	K	1KHz	19	0.520	0.68	0.51
SM7850-221K	220	K	1KHz	17	0.793	0.64	0.49
SM7850-271K	270	K	1KHz	15	0.884	0.56	0.42
SM7850-331K	330	K	1KHz	14	1.130	0.52	0.40
SM7850-391K	390	K	1KHz	12	1.300	0.44	0.36
SM7850-471K	470	K	1KHz	11	1.680	0.40	0.34
SM7850-561K	560	K	1KHz	10	1.900	0.38	0.32
SM7850-681K	680	K	1KHz	9	2.470	0.35	0.29
SM7850-821K	820	K	1KHz	8	2.860	0.30	0.25
SM7850-102K	1000	K	1KHz	7	3.640	0.25	0.19
SM7850-102K	1200	K	1KHz	5	3.640	0.23	0.17

• SM1040 Series Electrical Characteristics (Electrical specifications at 25°C)

Part No	Inductance			SRF	DCR	Saturation Current	Temperature Rise Current
	L(μH) '@0A	Tole	Test Freq	MHz Typ	(Ω) Max	(A) Max	(A) Max
SM1040-100M	10	M	2.52MHz	120	0.053	2.90	2.38
SM1040-120M	12	M	2.52MHz	100	0.061	2.55	2.13
SM1040-150M	15	M	2.52MHz	95	0.070	2.40	1.87
SM1040-180M	18	M	2.52MHz	85	0.071	2.10	1.73
SM1040-220M	22	M	2.52MHz	75	0.088	1.90	1.60
SM1040-270M	27	M	2.52MHz	62	0.100	1.65	1.44
SM1040-330M	33	M	2.52MHz	53	0.120	1.60	1.26
SM1040-390M	39	M	2.52MHz	47	0.151	1.40	1.20
SM1040-470K	47	K	2.52MHz	41	0.170	1.35	1.10
SM1040-560K	56	K	2.52MHz	38	0.199	1.20	1.01
SM1040-680K	68	K	2.52MHz	33	0.223	1.15	0.91
SM1040-820K	82	K	2.52MHz	31	0.252	1.00	0.85
SM1040-101K	100	K	1KHz	27	0.344	0.88	0.74
SM1040-121K	120	K	1KHz	23	0.396	0.80	0.69
SM1040-151K	150	K	1KHz	21	0.544	0.75	0.61
SM1040-181K	180	K	1KHz	19	0.621	0.64	0.56
SM1040-221K	220	K	1KHz	17	0.721	0.60	0.53
SM1040-271K	270	K	1KHz	15	0.949	0.56	0.45
SM1040-331K	330	K	1KHz	14	1.100	0.52	0.42
SM1040-391K	390	K	1KHz	12	1.245	0.48	0.38
SM1040-471K	470	K	1KHz	11	1.526	0.40	0.35
SM1040-561K	560	K	1KHz	10	1.904	0.35	0.32

• SM1054 Series Electrical Characteristics (Electrical specifications at 25°C)

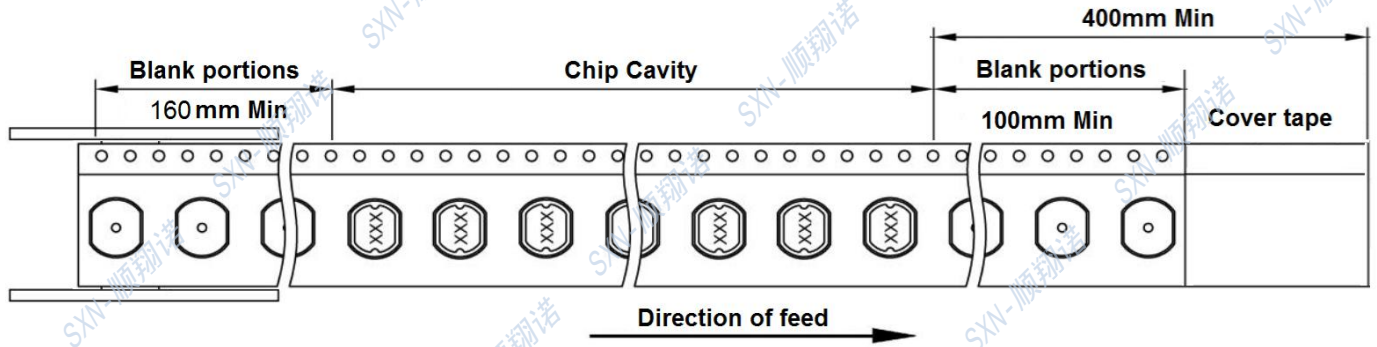
Part No	Inductance			SRF	DCR	Saturation Current	Temperature Rise Current
	L(μH) '@0A	Tole	Test Freq	MHz Typ	(Ω) Max	(A) Max	(A) Max
SM1054-100M	10	M	2.52MHz	120	0.06	4.00	2.60
SM1054-120M	12	M	2.52MHz	100	0.07	3.50	2.45
SM1054-150M	15	M	2.52MHz	95	0.08	3.00	2.27
SM1054-180M	18	M	2.52MHz	85	0.09	2.90	2.15
SM1054-220M	22	M	2.52MHz	75	0.10	2.55	1.95
SM1054-270M	27	M	2.52MHz	62	0.11	2.20	1.76
SM1054-330M	33	M	2.52MHz	53	0.12	2.10	1.50
SM1054-390M	39	M	2.52MHz	47	0.14	2.00	1.37
SM1054-470K	47	K	2.52MHz	41	0.17	1.95	1.28
SM1054-560K	56	K	2.52MHz	38	0.19	1.70	1.17
SM1054-680K	68	K	2.52MHz	33	0.22	1.50	1.11
SM1054-820K	82	K	2.52MHz	31	0.25	0.35	1.00
SM1054-101K	100	K	1KHz	27	0.35	1.20	0.97
SM1054-121K	120	K	1KHz	23	0.40	1.15	0.89
SM1054-151K	150	K	1KHz	21	0.47	1.05	0.78
SM1054-181K	180	K	1KHz	19	0.63	0.88	0.72
SM1054-221K	220	K	1KHz	17	0.73	0.85	0.66
SM1054-271K	270	K	1KHz	15	0.97	0.80	0.57
SM1054-331K	330	K	1KHz	14	1.15	0.75	0.52
SM1054-391K	390	K	1KHz	12	1.30	0.65	0.48
SM1054-471K	470	K	1KHz	11	1.48	0.56	0.42
SM1054-561K	560	K	1KHz	10	1.90	0.52	0.33
SM1054-681K	680	K	1KHz	9.3	2.25	0.48	0.28
SM1054-821K	820	K	1KHz	8.4	2.55	0.44	0.24
SM1054-102K	1000	K	1KHz	7	3.10	0.40	0.20

- Saturation Current: DC current at which inductance drops 10% from its value without current.
- Temperature Rise Current: the actual value of DC current when the temperature rise is $\Delta T 40^{\circ}\text{C}$ ($T_a=25^{\circ}\text{C}$).
- Rated DC Current: The less value which is Isat or Irms.
- Special remind: Circuit design, component, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

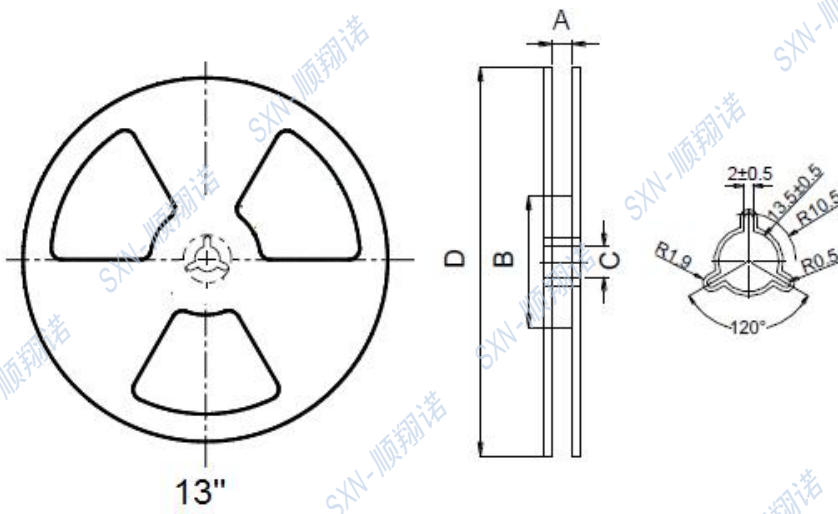
◆ 产品包装:

Packaging:

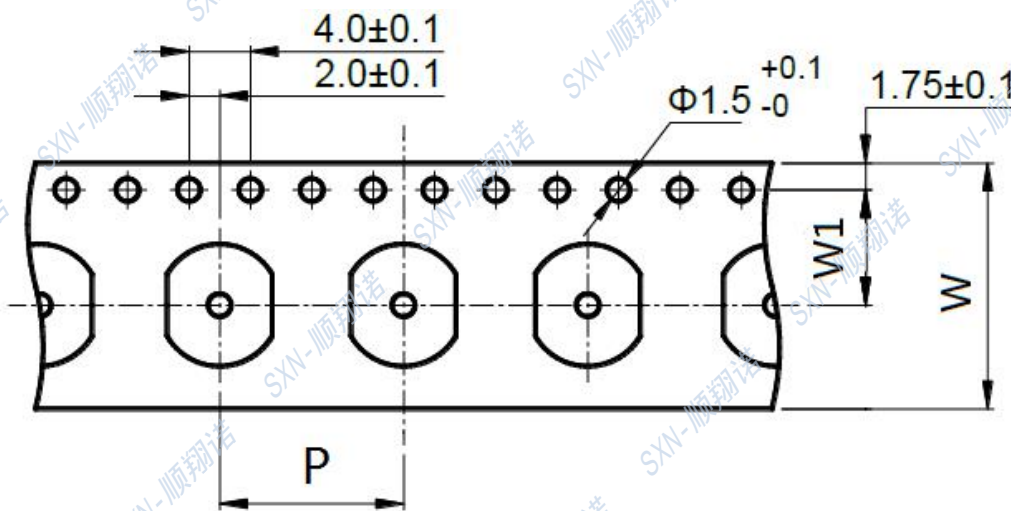
● Tape and Reel Specifications: (Dimensions are in mm)



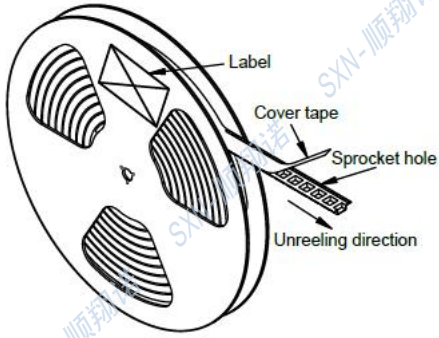
● Reel Dimensions (mm)



● Tape Dimension (mm)

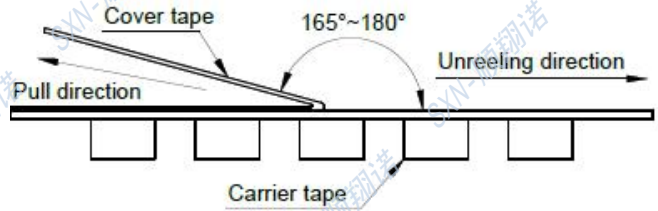


● Cover tape peel off condition

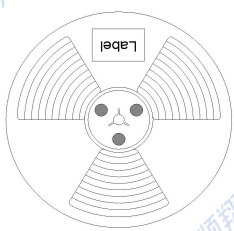


a) Cover tape peel force shall be 10 to 120g

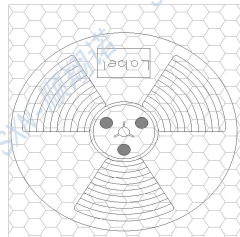
b) Noodle strip peeling angle 165° to 180°



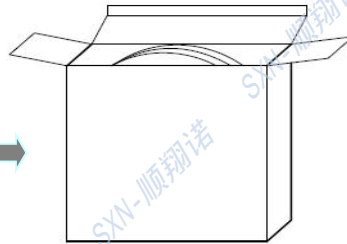
● Packing quantity



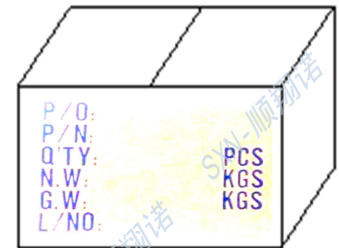
REEL



PE 袋



Inside Box



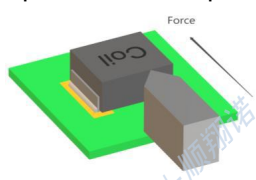

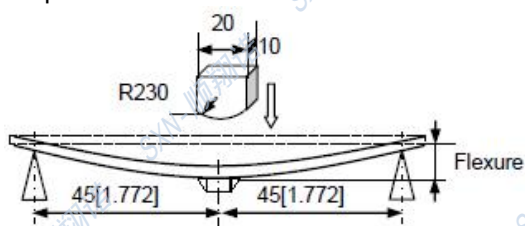
Outside Carton

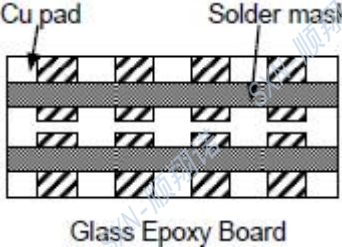
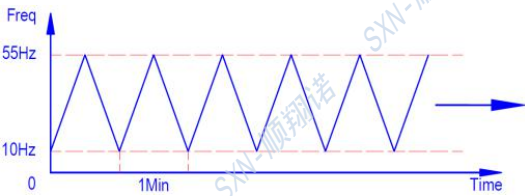
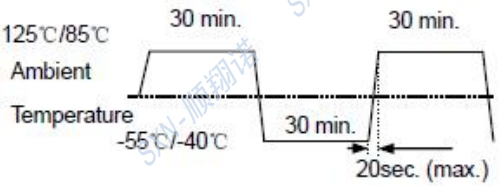
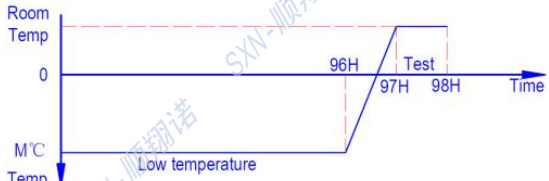
不足整箱用内盒或填充物装满

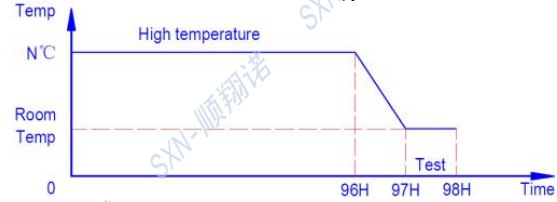
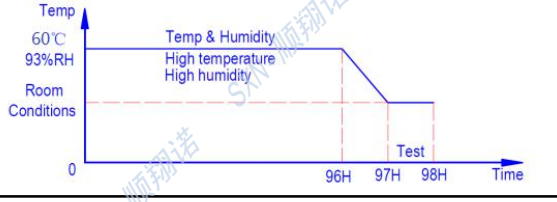
Part No.	Tape Dimension			Reel Dimensions				REEL (PCS)	Inside Box(PCS)	Outside Carton(PCS)
	W	P	W1	A	B	C	D			
SM3511	12	8	5.5	12.4	100	13	330	3000	12,000	48,000
SM3516	12	8	5.5	12.4	100	13	330	3000	12,000	48,000
SM3521	12	8	5.5	12.4	100	13	330	3000	12,000	48,000
SM4532	12	8	5.5	12.4	100	13	330	2000	8000	32,000
SM5825	16	8	7.5	16.4	100	13	330	2000	6000	24,000
SM5835	16	8	7.5	16.4	100	13	330	2000	6000	24,000
SM5845	16	8	7.5	16.4	100	13	330	1500	4500	18,000
SM7835	16	12	7.5	16.4	100	13	330	1000	3000	12,000
SM7850	16	12	7.5	16.4	100	13	330	1000	3000	12,000
SM1040	24	12	11.5	24.4	100	13	330	1000	2000	8000
SM1054	24	12	11.5	24.4	100	13	330	1000	2000	8000

◆可靠性测试:

Reliability Testing:

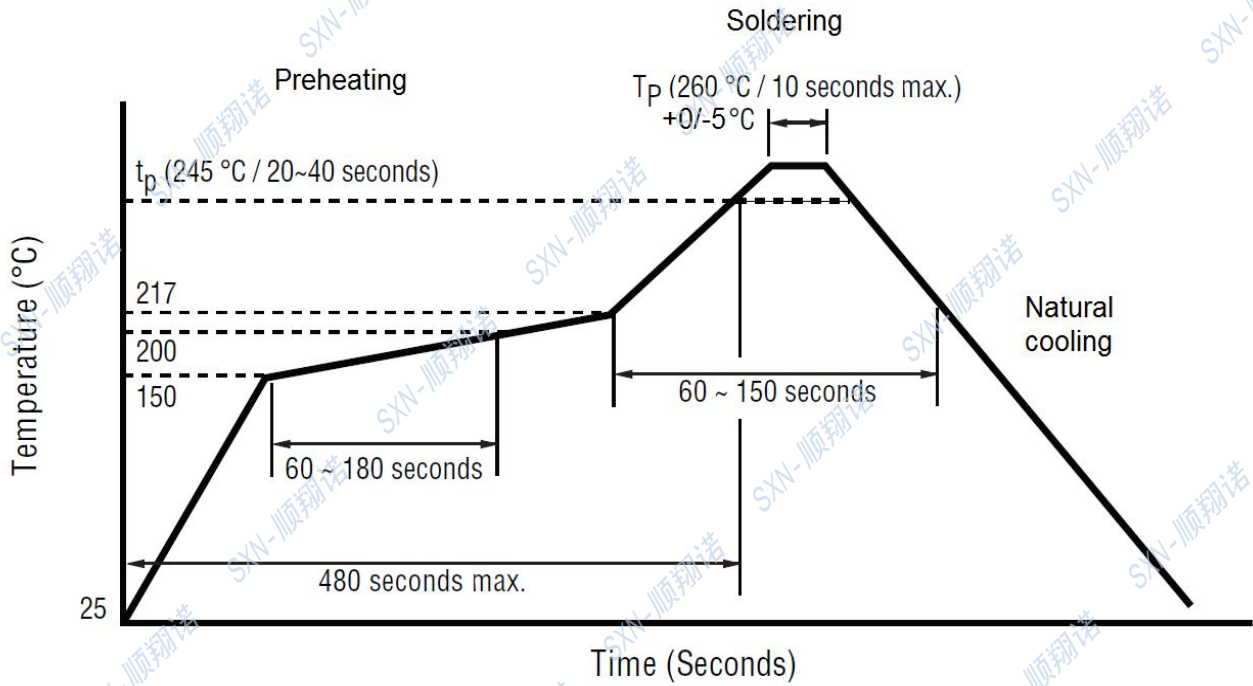
Items	Requirements	Test Methods and Remarks
Terminal Strength Reference documents: GB/T 2423.60-2008 端子强度(SMT)	1. Pulling test: Define: A: sectional area of terminal $A \geq 8\text{mm}^2$ force $\geq 5\text{N}$ time: 30sec $8\text{mm}^2 < A \leq 20\text{mm}^2$ force $\geq 10\text{N}$ time: 10sec $20\text{mm}^2 < A$ force $\geq 20\text{N}$ time: 10sec 2. Solder paste thickness: 0.12mm 3. Meet the above requirements without any loose terminal	Solder the inductor to the testing jig using leadfree solder. Then apply a force in the Keep time: $10 \pm 1\text{s}$ Speed: 1.0mm/s. 
Terminal Strength Reference documents: GB/T 2423.60-2008 端子强度(DIP)	1. Terminal diameter(d) mm $0.35 < d \leq 0.50$ Applied force: 5N Duration: 10sec 2. Terminal diameter(d) mm $0.50 < d \leq 0.80$ Applied force: 10N Duration: 10sec 3. Terminal diameter(d) mm $0.80 < d \leq 1.25$ Applied force: 20N Duration: 10sec 4. Terminal diameter(d) mm $D > 1.25$ Applied force: 40N Duration: 10sec 5. Meet the above requirements without any loose terminal.	Pull Force: the force shall be applied gradually to the terminal and then maintained for 10 seconds. 
Resistance to Flexure JIS C 5321:1997 抗弯曲性试验	1. No visible mechanical damage.	1. Solder the inductor to the test jig (glass epoxy board 2. shown in Using a leadfree solder. Then apply a force in the direction shown 3. Flexure: 2mm. 4. Pressurizing Speed: 0.5mm/sec. 5. Keep time: 30 sec. 
Dropping Reference documents: GB/T 2423.7-2018 落下试验	1. No case deformation or change in appearance. 2. No short and no open.	1. Drop the packaged products from 1m high in 1 angle, 3 ridges and 6 surfaces, twice in each direction.
Solderability Reference documents: GB/T 2423.28-2005 可焊性试验	1. No visible mechanical damage. 2. Wetting shall exceed 75% coverage for 3. Terminals must have 95% minimum solder coverage	1. Solder temperature: $240 \pm 2^\circ\text{C}$ 2. Duration: 3 sec. 3. Solder: Sn/3.0Ag/0.5Cu. 4. Flux: 25% Resin and 75% ethanol in weight

Items	Requirements	Test Methods and Remarks
<p>Vibration</p> <p>Reference documents: GB/T 2423.10-2019</p> <p>振動試驗</p>	<p>1.No visible mechanical damage.</p> <p>2. Inductance change: Within $\pm 10\%$.</p> <p>3. Q factor change: Within $\pm 20\%$.</p>  <p style="text-align: center;">Glass Epoxy Board</p>	<p>1.Solder the inductor to the testing jig (glass epoxy board shown in) using leadfree solder.</p> <p>2.The inductor shall be subjected to a simple harmonic motion having total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 and 55 Hz.</p> <p>3.The frequency range from 10 to 55 Hz and return to 10 Hz shall be traversed in approximately 1 minute. This motion shall be applied for a period of 2 hours in each 3 mutually perpendicular directions (total of 6 hours).</p> 
<p>Thermal Shock</p> <p>Reference documents: GB/T 2423.22-2012</p> <p>Method Na</p> <p>冷热冲击试验</p>	<p>1.No visible mechanical damage.</p> <p>2. Inductance change: Within $\pm 10\%$. (Mn-Zn: Within $\cong 30\%$)</p> <p>3. Q factor change: Within $\pm 20\%$.</p>	<p>1.Start at (85~125°C) for T time, rush to (-55~40°C) for T time as one cycle, go through 100 cycles.</p> <p>2.Transforming interval: Max. 20 sec.</p> <p>3.Tested cycle: 100 cycles.</p> <p>4.The chip shall be stabilized at normal condition for 1~2 hours</p> 
<p>Low temperature Storage</p> <p>Reference documents: GB/T 2423.1-2008</p> <p>Method Ab</p> <p>低温储存试验</p>	<p>1.No visible mechanical damage.</p> <p>2. Inductance change: Within $\pm 10\%$. (Mn-Zn: Within $\cong 30\%$)</p> <p>3. Q factor change: Within $\pm 20\%$.</p>	<p>1. Temperature: M(-55~-40$\pm 2^\circ\text{C}$)</p> <p>2. Duration: 96± 2 hours</p> <p>3. The chip shall be stabilized at normal condition for 1~2 hours before measuring.</p> 

Items	Requirements	Test Methods and Remarks
High temperature Storage Reference documents: GB/T 2423.2-2008 Method Bb 高温储存试验	1.No visible mechanical damage. 2. Inductance change: Within $\pm 10\%$.(Mn-Zn: Within $\cong 30\%$) 3.Q factor change: Within $\pm 20\%$.	1.Temperature:N($125\sim 85\pm 2^{\circ}\text{C}$). 2.Duration: 96 ± 2 hours 3.The chip shall be stabilized at normal condition for 1~2 hours before measuring. 
Damp Heat (Steady States) Reference documents: GB/T 2423.3-2016 恒定湿热试验	1.No visible mechanical damage. 2. Inductance change: Within $\pm 10\%$.(Mn-Zn: Within $\cong 30\%$) 3.Q factor change: Within $\pm 20\%$.	1.Temperature: $60\pm 2^{\circ}\text{C}$ 2.Humidity: 90% to 95% RH. 3.Duration: 96 ± 2 hours. 4.The chip shall be stabilized at normal condition for 1~2 hours before measuring. 
Heat endurance of Reflow soldering Reference documents: GJB 360B-2009 回流焊耐热性试验	1.No significant defects in appearance. 2. $\Delta L/L \cong 10\%$ (Mn-Zn: $\Delta L/L \cong 30\%$) 3. $\Delta Q/Q \cong 30\%$ (SMD series only) 4. $\Delta DCR/DCR \cong 10\%$	1.Refer to the above reflow curve and go through the reflow for twice. 2.The peak temperature : $260+0/-5^{\circ}\text{C}$
Resistance to solvent test Reference documents: IEC 68-2-45:1993 耐溶剂性试验	No case deformation or change in appearance or obliteration of marking	To dip parts into IPA solvent for 5 ± 0.5 Min, then drying them at room temp for 5Min, at last, to brushing making 10 times.
Overload test Reference documents: JIS C5311-6.13 过负荷试验	1.During the test no smoke, no peculiar, smell, no fire 2.The characteristic is normal after test	Apply twice as rated current for 5 minutes.
voltage resistance test Reference documents: MIL-STD-202G Method 301 绝缘耐压测试	1.During the test no breakdown 2.The characteristic is normal after test	1. For parts with two coils 2. DC1000V, Current: 1mA, Time: 1Min. 3. Refer to catalogue of specific products

◆ 推荐回流焊温度曲线

Recommended reflow soldering curve:



The recommended reflow conditions as above graph, is set according to our soldering equipment. DUE to various manufactures may have different reflow soldering equipment, products, process conditions, set methods. And so on, when setting the reflow conditions, Please adjust and confirm according to users' environment/equipment.

使用注意事项

REMINDERS FOR USING THESE PRODUCTS



- 保存时间为12 个月以内，保存条件（温度5~40°C以下、湿度35 ~ 66%RH 以下），需充分注意。若超过保存时间，端子电极的可焊性将可能老化。

The storage period is within 12 months. Be sure to follow the storage conditions (temperature: 5~40°C, humidity: 35 to 65% RH or less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate.

- 请勿在气体腐蚀环境（盐、酸、碱等）下使用和保存。

Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).

- 手上的油脂会导致可焊性降低，应避免用手直接接触端子。

Don't touch electrodes directly with bare hands as oil secretions may inhibit soldering. Always ensure optimum conditions for soldering.

- 请小心轻拿轻放，避免由于产品的跌落或取出不当而导致的损坏。

Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

- 端子过度弯曲会导致断线，请不要过度弯曲端子。

Don't bend the terminals with excessive stress in case of any wire fracture.

- 不要清洗产品，如需要清洗时请联系我司。

Don't rinse coils by yourself and please contact SXN if necessary.

- 请勿将本产品靠近磁铁或带有磁力的物体

Don't expose the products to magnets or magnetic fields

- 在实施焊接前，请务必进行预热。预热温度与焊接温度及芯片温度的温度差要在150°C 以内。

Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.

- 安装后的焊接修正应在规格书规定的条件范围内。若加热过度可能导致短路、性能降低、寿命减少。

Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.

- 装置会因通电而自我发热（温度上升），因此在热设计方面需留有充分余地。

Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.

- 非磁屏蔽型在基板设计时需注意配置线圈，受到电磁干扰可能会导致误动作。

Carefully lay out the coil for the circuit board design of the non-magnetic shield type. A malfunction may occur due to magnetic interference.